

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
A	INITIAL RELEASE	21MAR22	R. WHITNEY
B	CHANGES AS PER ECR-109842	24OCT22	R. WHITNEY
C	CHANGES AS PER ECR-115080	10AUG23	R. WHITNEY

HOLE TOLERANCE				
UNLESS SPECIFIED				
PLATED: +/-3MILS				
NON PLATED: +/-2MILS				
DRILL CHART: TOP to BOTTOM				
ALL UNITS ARE IN MILS				
FIGURE	SIZE	PLATED	QTY	TOLERANCE/NOTES
+	10.0	PLATED	1340	DIA MAX
□	35.0	PLATED	16	
◇	40.0	PLATED	10	
○	43.0	PLATED	8	
△	45.0	PLATED	71	
A	250.0	PLATED	4	
	16.0	NON-PLATED	4	
C	33.0	NON-PLATED	2	+2/-0
D	67.0	NON-PLATED	4	
E	67.0	NON-PLATED	4	
F	71.0	NON-PLATED	4	
G	125.0	NON-PLATED	4	
0	79.0x31.0	PLATED	4	

WWM
DIVISION
804 WOBURN STREET
WILMINGTON, MA 01887



TITLE
FABRICATION
EVAL - AD2437B1MZ
CUSTOMER EVALUATION Z

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES TOLERANCES DECIMALS FRACTIONS ANGLES .XX -.010 --1/32 -- 2 .XXX -.005 .XXXX -.0050	APPROVAL TEMPLATE ENGINEER N/A	DATE N/A	SIZE FSCM NO DRAWING NUMBER REV C 24355 09-067219 C			
	HARDWARE SERVICES M. VALE	21MAR22				
MATERIAL	HARDWARE SYSTEMS		SCALE 1/1 SHEET 1 OF 2			
	TEST ENGINEER					
	COMPONENT ENGINEER A. GIRON	21MAR22				
FINISH	TEST PROCESS		DO NOT SCALE DWG			
	HARDWARE RELEASE K. JABATAN	21MAR22				
	DESIGNER M. VICEDO	21MAR22				
	PTD ENGINEER R. WHITNEY	21MAR22				
	CHECKER					



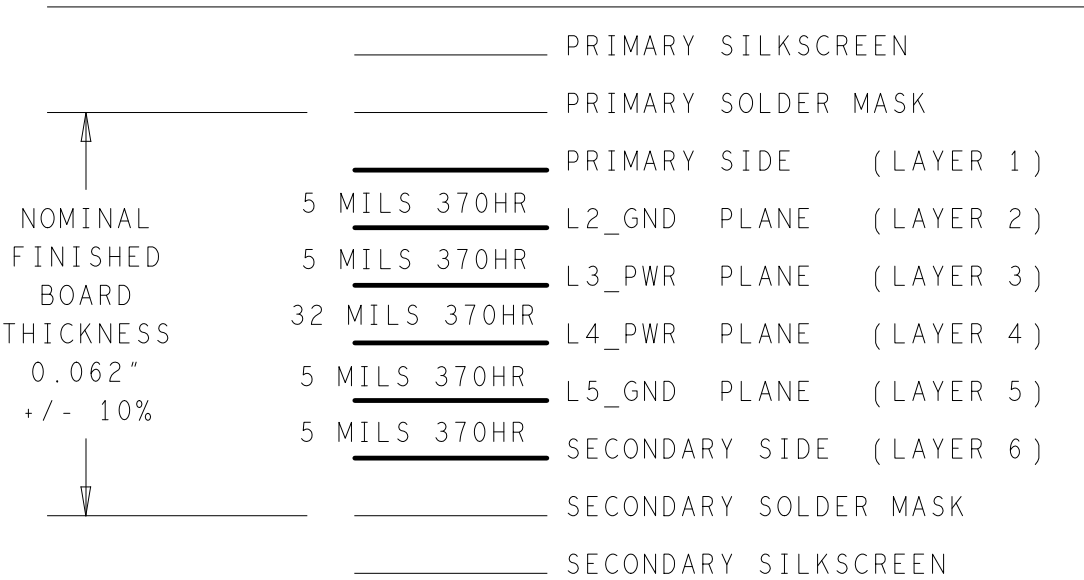
SPECIFICATIONS:

- ROHS COMPLIANCE NOTE: HOMOGENOUS MATERIALS IN THIS BOARD SHALL BE COMPLIANT THE EU RoHS DIRECTIVE 2002/95/EC
- MATERIALS: ALL LAMINATES AND BONDING MATERIALS SHOULD BE SELECTED FROM IPC-4101 OR IPC-4103, MINIMUM Tg>170degC, Td>300degC, U.L. RATING OF 94 V-0
- MATERIAL FAMILY: ISOLA 370HR
- CLADDING: EXTERNAL LAYERS .5 OZ. COPPER, OVERPLATE TO 1.5 OZ. INTERNAL PLANE LAYERS 1 OZ. COPPER.
- NOTE: IF THE LAYER STACKUP CONFLICTS WITH THE ABOVE CLADDING SPECIFICATIONS THEN THE LAYER STACKUP SHALL TAKE PRECEDENCE.
- SOLDER MASK: SHALL BE LIQUID PHOTOIMAGEABLE (LPI) APPLIED ON BOTH SIDES OVER BARE COPPER OR GOLD AND SHALL MEET IPC-SM-840 (LATEST REV.) CLASS 3. COLOR GREEN.
- SILK SCREEN: SHALL BE PERMANENT NON-CONDUCTIVE EPOXY INK, COLOR: WHITE SYNTHETIC INKJET PRINTING ALLOWED FOR DENSE BOARDS, COLOR: WHITE
- SURFACE FINISH: ENIG (ELECTROLESS NICKEL/IMMERSION GOLD) PER IPC-4552 LATEST REVISION
- INTENTIONAL SHORTS: IF SUPPLIED DATA INCLUDES A FILE "READ_ME.2", THEN INTENTIONAL NET SHORTS EXIST. CUSTOMER REVIEW AND APPROVAL IS REQUIRED IF SUPPLIED DATA REPORTS ANY CONDITION THAT DOES NOT MATCH "READ_ME.2" FILE PROVIDED.
- TEST REQUIREMENTS: 100% NETLIST ELECTRICAL VERIFICATION USING CUSTOMER SUPPLIED IPC-D-356 NETLIST FOR OPENS AND SHORTS WHEN "GERBER DATA" IS PROVIDED. THIS VERIFICATION ALSO REQUIRED FOR "ODB++" DATA PER EMBEDDED NETLIST.

REQUIREMENTS:

- REFER TO IPC-6010 SERIES (LATEST REV.), CLASS 2 FOR FABRICATION UNLESS OTHERWISE SPECIFIED.
- ACCEPTABILITY PER ANALOG DEVICES, INC. SPECIFICATION TST00115, (LATEST REVISION.)
- MODIFICATIONS TO THE ARTWORK ARE NOT ALLOWED WITHOUT WRITTEN AUTHORIZATION.
- HOLE PATTERN TOLERANCES FOR UNDIMENSIONED HOLES SHALL BE A DIAMETER OF 0.005 INCHES FROM THEIR TRUE POSITION.
- PLATED HOLE WALL THICKNESS SHALL NOT BE LESS THAN 0.001 INCH MINIMUM AVERAGE, WITH NO READING LESS THAN .0008 INCH BY CROSS SECTION.
- HOLE DIAMETERS APPLY AFTER PLATING.
- FINISHED CONDUCTOR WIDTHS SHALL NOT BE REDUCED FROM THE NOMINAL INDICATED ON THE MASTER PATTERN, BY MORE THAN THE CONDUCTOR THICKNESS.
- MINIMUM DESIGN LINE WIDTH IS .007 INCH.
- MINIMUM DESIGN SPACING IS .00373 INCH.
- ~~NON-FUNCTIONAL PAD REMOVAL FROM INNER SIGNAL LAYERS MAY BE PERFORMED AFTER CUSTOMER APPROVAL.~~
- IF PAD SIZES PROVIDED ARE NOT LARGE ENOUGH TO MAINTAIN ANNULAR RING REQUIREMENT, MFGR. MAY REQUEST APPROVAL TO TEAR DROP PADS TO MAINTAIN ANNULAR RING. (AT PAD TO TRACE INTERSECTION ONLY AND ELECTRICAL INTEGRITY MUST BE MAINTAINED.)
- THIEVING MAY BE ADDED TO COMPENSATE FOR LOW COPPER DENSITY AREAS ON THIS DESIGN ONLY AFTER REVIEW AND APPROVAL FROM THE CUSTOMER:
 - THIEVING TO CARD EDGE, FIDUCIALS, NON-PLATED THROUGH HOLES, ALL OTHER FEATURES TO BE 0.200 INCH MINIMUM.
 - THERE SHALL BE NO THIEVING IN ANY AREAS FREE OF SOLDER MASK OR INTERNAL COPPER PLANES.
- MFGR. TO LEGIBLY ETCH OR STAMP/SCREEN WITH PERMANENT NON-CONDUCTIVE INK ON SECONDARY SIDE IN A CLEAR AREA UNLESS OTHERWISE INDICATED;
 - U.L. CODE-FLAMMABILITY RATING
 - DATE CODE (STAMP).
 - LOT NUMBER
 - MFGR LOGO
 - SUCCESSFUL ELECTRICAL TEST.
- REPAIRS PER IPC-7711/21 (LATEST REV.) ARE ALLOWED.
~~REPAIRS ARE NOT ALLOWED IN ANY AREA DEFINED ON GOLD_PRM AND/OR GOLD_SEC ARTWORK LAYERS WHEN PROVIDED IN GERBER OR ODB++ DATA.~~
- BOARDS TO BE SHIPPED IN ARRAY AND KEEP INTACT. PANEL TO BE SUBJECTED TO CUSTOMER'S APPROVAL. PANELED SOLDER PASTE STENCIL SHOULD BE SENT TO THE CUSTOMER.

6 LAYER STACKUP




IMPEDANCE TABLE

NOTE: ALL IMPEDANCE TOLERANCE +/-10%
SE = SINGLE ENDED
DP = DIFFERENTIAL PAIR

LAYER	IMPEDANCE	REFERENCE	LINE WIDTH	SPACE
L1	100 OHMS DP	L3	9.5 MILS	6.5 MILS
L1	50 OHMS SE	L2	7 MILS	N/A
L3	50 OHMS SE	L2	7 MILS	N/A
L6	50 OHMS SE	L5	7 MILS	N/A

PRIMARY SIDE



WWM
DIVISION
804 WOBURN STREET
WILMINGTON, MA 01887

SIZE	FSCM NO	DRAWING NUMBER	REV
C	24355	09-067219	C
SCALE	1/1	SHEET 2 OF 2	